



BSI Standards Publication

Materials for printed boards and other interconnecting structures

Part 2-51: Reinforced base materials, clad and unclad — Base materials for integrated circuit card carrier tape, unclad

National foreword

This British Standard is the UK implementation of EN IEC 61249-2-51:2023. It is identical to IEC 61249-2-51:2023.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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Published by BSI Standards Limited 2023

ISBN 978 0 539 18768 7

ICS 29.035.10; 31.180

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This British Standard was published under the authority of the Standards Policy and Strategy Committee on 30 June 2023.

Amendments/corrigenda issued since publication

Date	Text affected
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